# Ultra Field Stop IGBT, 1200 V, 60 A

## FGY60T120SQDN

## **General Description**

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Ultra Field Stop Trench construction, and provides superior performance in demanding switching applications, offering both low on–state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co–packaged free wheeling diode with a low forward voltage.

#### **Features**

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature  $T_J = 175$ °C
- Low Saturation Voltage:  $V_{CE(sat)} = 1.7 \text{ V (Typ.)}$  @  $I_C = 60 \text{ A}$
- 100% of the Parts Tested for I<sub>LM</sub> (Note 1)
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- RoHS Compliant

## **Applications**

• Solar Inverter, UPS

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Description	Value	Unit
V <sub>CES</sub>	Collector to Emitter Voltage	1200	V
V <sub>GES</sub>	Gate to Emitter Voltage	±25	V
	Transient Gate to Emitter Voltage	±30	V
I <sub>C</sub>	Collector Current @ (T <sub>C</sub> = 25°C)	120	Α
	Collector Current @ (T <sub>C</sub> = 100°C)	60	Α
I <sub>LM</sub> (1)	Pulsed Collector Current @ (T <sub>C</sub> = 25°C)	240	Α
I <sub>CM</sub> (2)	Pulsed Collector Current	240	Α
IF	Diode Forward Current @ (T <sub>C</sub> = 25°C)	120	Α
	Diode Forward Current @ (T <sub>C</sub> =100°C)	60	Α
I <sub>FM</sub>	Pulsed Diode Max. Forward Current	240	Α
P <sub>D</sub>	Maximum Power Dissipation	F47	W
	@ (T <sub>C</sub> = 25°C) @ (T <sub>C</sub> =100°C)	517 259	W
TJ	Operating Junction Temperature	-55 to +175	°C
T <sub>stg</sub>	Storage Temperature Range	-55 to +175	°C
TL	Maximum Lead Temp. For soldering Purposes, 1/8" from case for 5 seconds	300	°C

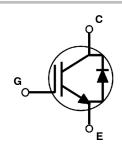
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

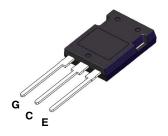
- 1. VCC = 800 V,  $V_{GE}$  = 15 V,  $I_{C}$  = 240 A,  $R_{G}$  = 68  $\Omega$ , Inductive Load
- 2. Repetitive rating: Pulse width limited by max. Junction temperature



## ON Semiconductor®

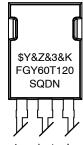
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Power TO247 (TO-247H03)

## **MARKING DIAGRAM**



&Y = ON Semiconductor Logo &3 = Data Code (Year & Week)

&K = Lot

FGY60T120SQDN= Specific Device Code

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 3 of this data sheet.

## THERMAL CHARACTERISTICS

Symbol	Parameter	FGY60T120SQDN	Unit
R <sub>θJC</sub> (IGBT)	Thermal Resistance, Junction to Case, Max.	0.29	°C/W
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case, Max.	0.42	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

## **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit	
OFF CHARACTERISTICS							
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 500 \mu A$	1200	-	-	V	
I <sub>CES</sub>	Collector Cut-Off Current	$V_{CE} = V_{CES}$ , $V_{GE} = 0 V$	-	-	400	μΑ	
I <sub>GES</sub>	G-E Leakage Current	V <sub>GE</sub> = V <sub>GES</sub> , V <sub>CE</sub> = 0 V	_	-	±200	nA	
ON CHARAC	TERISTICS						
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_C = 400 \mu A, V_{CE} = V_{GE}$	4.5	5.5	6.5	V	
		I <sub>C</sub> = 60 A <sub>,</sub> V <sub>GE</sub> = 15 V	-	1.7	1.95	V	
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	I <sub>C</sub> = 60 A, V <sub>GE</sub> = 15 V, T <sub>C</sub> = 175°C	_	2.3	_	V	
DYNAMIC CI	HARACTERISTICS	!	1				
C <sub>ies</sub>	Input Capacitance		_	7147	-	pF	
C <sub>oes</sub>	Output Capacitance	$V_{CE} = 20 \text{ V, } V_{GE} = 0 \text{ V,}$ f = 1  MHz	_	203	-	pF	
C <sub>res</sub>	Reverse Transfer Capacitance	1 – 1 141112	_	114	-	pF	
SWITCHING CHARACTERISTICS							
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{CC}$ = 600 V, $I_{C}$ = 60 A, $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15 V,	_	52	-	ns	
t <sub>r</sub>	Rise Time		_	84	-	ns	
td(off)	Turn-Off Delay Time		_	296	-	ns	
t <sub>f</sub>	Fall Time	Inductive Load, $T_C = 25^{\circ}C$	_	56	-	ns	
Eon	Turn-On Switching Loss		-	5.15	-	mJ	
Eoff	Turn-Off Switching Loss		_	1.82	-	mJ	
Ets	Total Switching Loss		_	6.97	-	mJ	
td(on)	Turn-On Delay Time		_	40	-	ns	
t <sub>r</sub>	Rise Time	$V_{CC} = 600 \text{ V}, I_{C} = 60 \text{ A}, R_{G} = 10 \Omega,$	-	72	-	ns	
td(off)	Turn-Off Delay Time	$V_{GE} = 15 \text{ V},$	-	324	-	ns	
t <sub>f</sub>	Fall Time	Inductive Load, T <sub>C</sub> = 175°C	-	144	-	ns	
Eon	Turn-On Switching Loss		_	7.18	-	mJ	
Eoff	Turn-Off Switching Loss		_	3.1	-	mJ	
Ets	Total Switching Loss		-	10.28	-	mJ	
$Q_g$	Total Gate Charge	V 200 V I 25 1 V 1 1 - 1 - 1	-	311	-	nC	
Qge	Gate to Emitter Charge	$V_{CE} = 600 \text{ V}, I_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V}$	-	57	-	nC	
Qgc	Gate to Collector Charge		_	153	-	nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## **ELECTRICAL CHARACTERISTICS OF THE DIODE** ( $T_C = 25$ °C unless otherwise noted)

Symbol	Parameter	Test Condition		Min.	Тур.	Max.	Unit
.,,	Diede Feerend Vellere		T <sub>C</sub> = 25°C	-	3.4	4	
$V_{FM}$	Diode Forward Voltage	ge	T <sub>C</sub> = 175°C	-	3.2	-	V
	Dieda De com Decembra	I <sub>F</sub> = 60 A	T <sub>C</sub> = 25°C	-	91	-	ns
t <sub>rr</sub>	Diode Reverse Recovery Time		T <sub>C</sub> = 175°C	-	309	-	
Q <sub>rr</sub> Dic	Dieda Barrara Barrara Charra		T <sub>C</sub> = 25°C	-	860	_	nC
	Diode Reverse Recovery Charge		T <sub>C</sub> = 175°C	-	4902	-	
I <sub>rrm</sub>	Diada Danasa Danasa Ormada		T <sub>C</sub> = 25°C	-	19	_	Α
	Diode Reverse Recovery Current		T <sub>C</sub> = 175°C	-	32	-	

## PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Quantity
FGY60T120SQDN	FGY60T120SQDN	TO-247-3LD (Pb-Free)	30/Tube

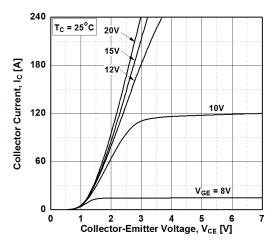


Figure 1. Typical Output Characteristics

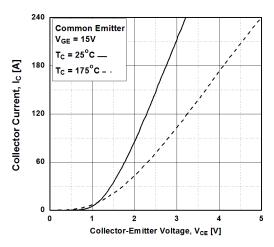


Figure 3. Typical Saturation Voltage Characteristics

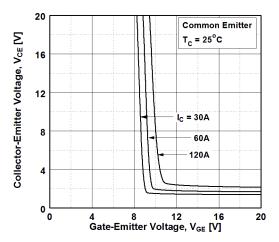


Figure 5. Saturation Voltage vs.  $V_{\text{GE}}$ 

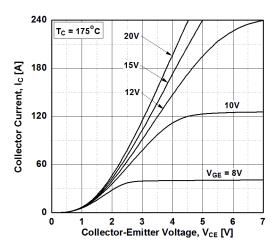


Figure 2. Typical Output Characteristics

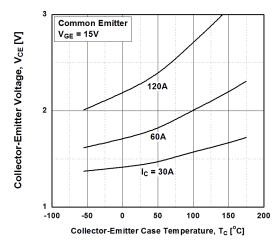


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

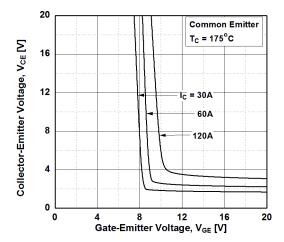


Figure 6. Saturation Voltage vs. V<sub>GE</sub>

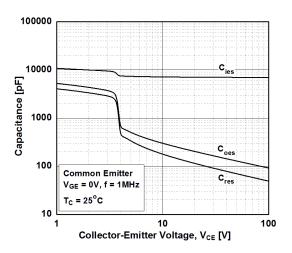


Figure 7. Capacitance Characteristics

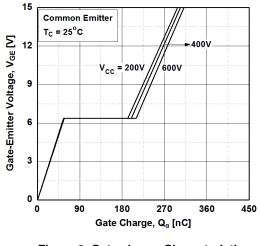


Figure 8. Gate charge Characteristics

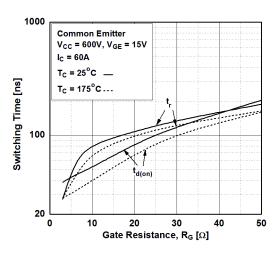


Figure 9. Turn-on Characteristics vs. Gate Resistance

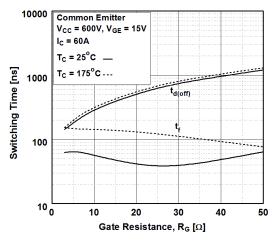


Figure 10. Turn-off Characteristics vs. Gate Resistance

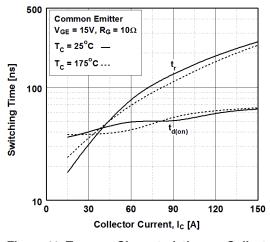


Figure 11. Turn-on Characteristics vs. Collector Current

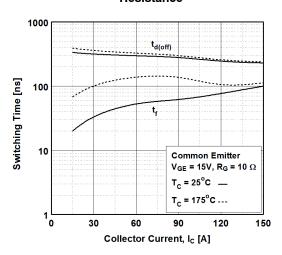


Figure 12. Turn-off Characteristics vs. Collector Current

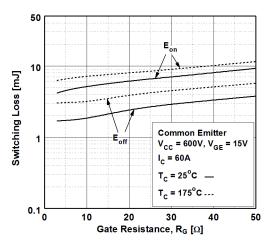


Figure 13. Switching Loss vs. Gate Resistance

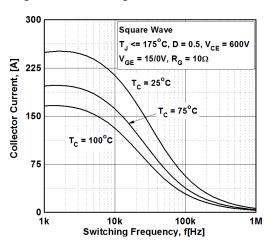


Figure 15. Load Current vs. Frequency

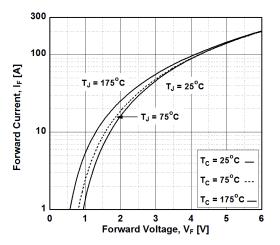


Figure 17. Forward Characteristics

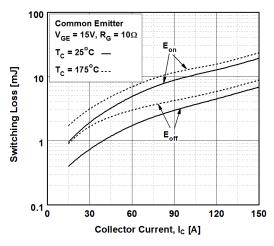


Figure 14. Switching Loss vs. Collector Current

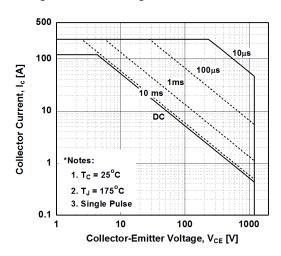


Figure 16. SOA Characteristics

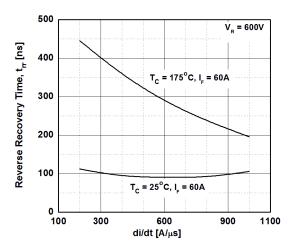
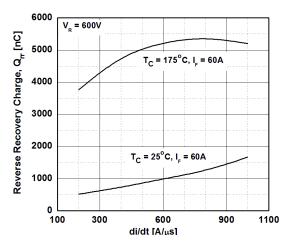


Figure 18. Reverse Recovery Time vs. di<sub>F</sub>/dt



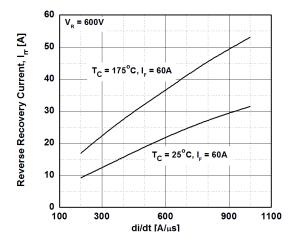


Figure 19. Reverse Recovery Charge vs.  $di_{\text{F}}/dt$ 

Figure 20. Reverse Recovery Current vs. di<sub>F</sub>/dt

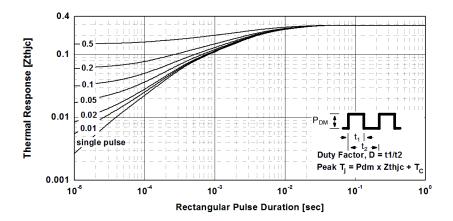


Figure 21. Transient Thermal Impedance if IGBT

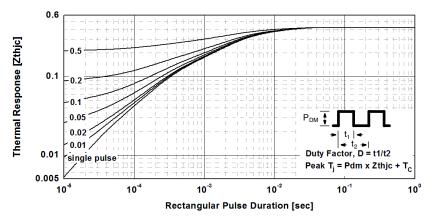


Figure 22. Transient Thermal Impedance if Diode

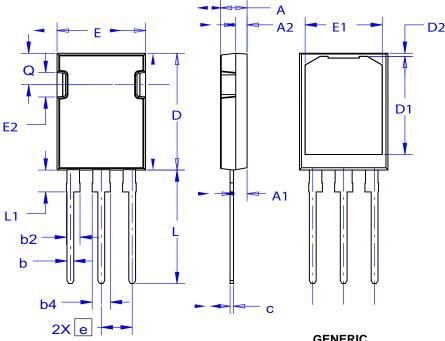


TO-247-3LD CASE 340CD ISSUE A

**DATE 18 SEP 2018** 

### NOTES:

- A. THIS PACKAGE DOES NOT CONFORM TO ANY STANDARDS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.



DIM	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	4.58	4.70	4.82	
<b>A</b> 1	2.20	2.40	2.60	
A2	1.80	2.00	2.20	
D	20.32	20.57	20.82	
Е	15.37	15.62	15.87	
E2	4.12	4.32	4.52	
е	~	5.45	~	
L	19.90	20.00	20.10	
L1	3.69	3.81	3.93	
Q	5.34	5.46	5.58	
b	1.10	1.20	1.30	
b2	2.10	2.24	2.39	
b4	2.87	3.04	3.20	
С	0.51	0.61	0.71	
D1	16.63	16.83	17.03	
D2	0.51	0.93	1.35	
E1	13.40	13.60	13.80	

GENERIC
MARKING DIAGRAM\*

XXXXXXXX AYWWG

XXXX = Specific Device Code A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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 GT50JR22(STA1ES)
 TIG058E8-TL-H
 VS-CPV364M4KPBF
 NGTB25N120FL2WAG
 NGTG40N120FL2WG
 RJH60F3DPQ-A0#T0

 APT40GR120B2SCD10
 APT15GT120BRG
 APT20GT60BRG
 NGTB75N65FL2WAG
 NGTG15N120FL2WG
 IXA30RG1200DHGLB

 IXA40RG1200DHGLB
 APT70GR65B2DU40
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 APT70GR120J
 APT35GP120JDQ2

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